

**27**

**28.** The method of claim **25** wherein each of the openings extends partially into a respective one of the spacers features.

**29.** The method of claim **24** further including:

subsequently separating the structure attached to the support substrate into multiple optoelectronic modules each of which includes at least one of the optoelectronic devices.

\* \* \* \* \*

**28**